

4G PRODUCT

CM2

SPECIFICATION



Note: due to product version upgrade or other reasons, the content of this document will be updated without prior notice. Unless otherwise agreed, all statements, information and recommendations in this document do not constitute any warranty, express or implied.

■ ID



■ Application scenarios



■ Spec

Hardware Platform	Chipset	G306
Protocol	LTE TDD/FDD	Cat. 1, Downlink/Uplink up to 10Mbps/5Mbps
RF BAND	Asia Band1	LTE FDD : B1/ B3 /B5 /B8 LTE TDD: B34/B38/B39/B40/B41
	Eu Band2	LTE FDD: B1/B3/B5/B7/B8/B20/B28(28A、28B) LTE TDD: B38/B40/B41
Antenna	Internal Antenna connector	LTE Main*1
External Interface	SIM card slot	Nano SIM card and Esim
	Power interface	DC
	RJ45	LAN
Indicator	LED indicator	SYS/4G
Power Supply	DC	5-28V
Software		
WEBUI	Device Status	support
	APN Setting	support
	SIM card switch	support
	Online keeper	support
	Reboot	support
	Restore factory	support
	Local upgrade	support
Environment	Working Temperature	0~45℃
	Storage Temperature	-20~70℃